





MULTI HORNET

(ORG1518-R02)

GPS / GNSS MODULE WITH INTEGRATED ANTENNA

Datasheet

Origin GPS.com





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1. SCOPE

This document describes the features and specifications of Multi Hornet ORG1518 GPS / GNSS module with integrated antenna.

2. DISCLAIMER

All trademarks are properties of their respective owners.

Performance characteristics listed in this document do not constitute a warranty or guarantee of product performance. OriginGPS assumes no liability or responsibility for any claims or damages arising out of the use of this document, or from the use of integrated circuits based on this document.

OriginGPS assumes no liability or responsibility for unintentional inaccuracies or omissions in this document. OriginGPS reserves the right to make changes in its products, specifications and other information at any time without notice.

OriginGPS reserves the right to conduct, from time to time, and at its sole discretion, firmware upgrades. As long as those FW improvements have no material change on end customers, PCN may not be issued. OriginGPS navigation products are not recommended to use in life saving or life sustaining applications.

3. SAFETY INFORMATION

Improper handling and use can cause permanent damage to the product.

4. ESD SENSITIVITY

This product is ESD sensitive device and must be handled with care.



5. CONTACT INFORMATION

Support - <u>support@origingps.com</u> or <u>Online Form</u>
Marketing and sales - <u>marketing@origingps.com</u>
Web - www.origingps.com

6. RELATED DOCUMENTATION

Nº	DOCUMENT NAME
1	Multi Hornet – ORG1518-R02 Evaluation Kit Datasheet
2	Spider and Hornet - NMEA Protocol Reference Manual
3	Spider and Hornet - One Socket Protocol Reference Manual
4	Spider and Hornet - One Socket Protocol Extension Reference Manual
5	SiRFLive FAQ

TABLE 1 - RELATED DOCUMENTATION





7. REVISION HISTORY

REVISION	DATE	CHANGE DESCRIPTION
1.0	October 10, 2016	First release
1.1	December 21, 2016	Wakeup I/O output update 1.8V. Vcc range update
1.2	February 6, 2017	Starting the module update, module orientation on PCB update
		Recommended Operating Conditions table update Boot Mode update Recommended PCB layout update
1.3	March 8, 2017	Transition to Hibernate update Mechanical Specifications Update 10Hz update rate V_backup update, including architecture scheme

TABLE 2 - REVISION HISTORY

8. GLOSSARY

A-GPS Assisted GPS

ABP™ Almanac Based Position

AC Alternating Current

ADC Analog to Digital Converter

AGC Automatic Gain Control

APM™ Adaptive Power Management

ATP™ Adaptive Trickle Power

BBRAM Battery Backed-up RAM

BE Broadcast Ephemeris

BPF Band **P**ass **F**ilter

C/N₀ Carrier to Noise density ratio [dB-Hz]

CDM Charged Device Model

CE European Community conformity mark

CEP Circular Error Probability

CGEE™ Client **G**enerated **E**xtended **E**phemeris

CMOS Complementary Metal-Oxide Semiconductor

CPU Central Processing Unit

CTS Clear-To-Send

CW Continuous Wave

DC Direct Current

DOP Dilution Of Precision

DR Dead Reckoning

DSP Digital Signal Processor

ECEF Earth Centred Earth Fixed

ECHA European Chemical Agency

EE Extended Ephemeris

EGNOS European Geostationary Navigation Overlay Service

EIA Electronic Industries Alliance

EMC Electro-Magnetic Compatibility

EMI Electro-Magnetic Interference

ENIG Electroless **N**ickel Immersion **G**old

ESD Electro-Static Discharge

ESR Equivalent Series Resistance

EU European Union





EVB Evaluation Board

EVK Evaluation Kit

FCC Federal **C**ommunications **C**ommission

FSM Finite State Machine

GAGAN GPS Aided Geo-Augmented Navigation

GNSS Global Navigation Satellite System

GPIO General Purpose Input or Output

GPS Global Positioning System

HBM Human **B**ody **M**odel

HDOP Horizontal Dilution Of Precision

I²C Inter-Integrated Circuit

I/O Input or Output

IC Integrated Circuit

ICD Interface Control Document

IF Intermediate Frequency

ISO International Organization for Standardization

JEDEC Joint Electron Device Engineering Council

KA Keep Alive

KF Kalman Filter

LDO Low Dropout regulator

LGA Land Grid Array

LNA Low Noise Amplifier

LP Low Power

LS Least Squares

LSB Least Significant Bit

MID Message Identifier

MM Machine Model

MPM™ Micro Power Mode

MSAS Multi-functional Satellite Augmentation System

MSB Most Significant Bit

MSL Moisture Sensitivity Level

NFZ™ Noise-Free Zones System

NMEA National Marine Electronics Association

NVM Non-Volatile Memory

OSP® One Socket Protocol

PCB Printed Circuit Board

PLL Phase Lock Loop

PMU Power Management Unit

POR Power-On Reset

PPS Pulse Per Second

PRN Pseudo-Random Noise

PSRR Power Supply Rejection Ratio

PTF™ Push-To-Fix

QZSS Quasi-Zenith Satellite System

RAM Random Access Memory

REACH Registration, Evaluation, Authorisation and Restriction of Chemical substances

RF Radio Frequency

RHCP Right-Hand Circular Polarized

RMS Root Mean Square

RoHS Restriction of Hazardous Substances directive

ROM Read-Only Memory





RTC Real-Time Clock

RTS Ready-To-Send

SAW Surface Acoustic Wave

SBAS Satellite-Based Augmentation Systems

SGEE™ Server Generated Extended Ephemeris

SID Sub-Identifier

SIP System In Package

SMD Surface Mounted Device

SMPS Switched Mode Power Supply

SMT Surface-Mount Technology

SOC System On Chip

SPI Serial **P**eripheral Interface

SSB® SiRF Standard Binary

SV Satellite Vehicle

TCXO Temperature-Compensated Crystal Oscillator

TTFF Time To First Fix

TTL Transistor-Transistor Logic

UART Universal Asynchronous Receiver/Transmitter

VCCI Voluntary Control Council for Interference by information technology equipment

VEP Vertical Error Probability

VGA Variable-Gain Amplifier

WAAS Wide Area Augmentation System

9. ABOUT HORNET FAMILY

OriginGPS GNSS receiver modules have been designed to address markets where size, weight, stand-alone operation, highest level of integration, power consumption and design flexibility - all are very important.

OriginGPS' Hornet family breaks size barrier, offering the industry's smallest fully-integrated, highly-sensitive GPS and GNSS modules with integrated antennas or on-board RF connectors.

Hornet family features OriginGPS' proprietary NFZ™ technology for high sensitivity and noise immunity even under marginal signal condition, commonly found in urban canyons, under dense foliage or when the receiver's position in space rapidly changes.

Hornet family enables the shortest TTM (Time-To-Market) with minimal design risks.

Just connect power supply on a single layer PCB.

10. ABOUT MULTI HORNET MODULE

Multi Hornet is a complete SiP featuring miniature LGA SMT footprint designed to commit unique integration features for high volume cost sensitive applications.

Designed to support compact and traditional applications, Multi Hornet ORG1518 module is a miniature multi-channel GPS/ GLONASS with SBAS, QZSS and other regional overlay systems receiver that continuously tracks all satellites in view, providing real-time positioning data in industry's standard NMEA format.

Multi Hornet ORG1518 module offers superior sensitivity and outstanding performance, achieving rapid TTFF in less than one second, accuracy of approximately two meters, and tracking sensitivity of -165dBm.

Sized only 18mm x 18mm Multi Hornet ORG1518 module is record breaking solution.

Multi Hornet module integrates OriginGPS proprietary on-board GPS antenna, dual-stage LNA, RF LDO, SAW filter, TCXO, RTC crystal and RF shield with market-leading SiRFstarV™ GNSS SoC.

Multi Hornet ORG1518 module is introducing industry's lowest energy per fix ratio, unparalleled accuracy and extremely fast fixes even under challenging signal conditions, such as in built-up urban areas, dense foliage or even indoor.





Integrated GPS SoC incorporating high-performance microprocessor and sophisticated firmware keeps positioning payload off the host, allowing integration in embedded solutions with low computing resources. Innovative architecture can detect changes in context, temperature, and satellite signals to achieve a state of near continuous availability by maintaining and opportunistically updating its internal fine time, frequency, and satellite ephemeris data while consuming mere microwatts of battery power.

11. ABOUT ORIGINGPS

OriginGPS is a world leading designer, manufacturer and supplier of miniature positioning modules, antenna modules and antenna solutions.

OriginGPS modules introduce unparalleled sensitivity and noise immunity by incorporating Noise Free Zone system (NFZ $^{\text{\tiny{M}}}$) proprietary technology for faster position fix and navigation stability even under challenging satellite signal conditions.

Founded in 2006, OriginGPS is specializing in development of unique technologies that miniaturize RF modules, thereby addressing the market need for smaller wireless solutions.

12. DESCRIPTION

12.1. FEATURES

- Autonomous operation
- Active antenna on-board
- Pin to pin compatible with ORG1218, ORG1415, ORG1418 (Consult OriginGPS when changing to ORG1518 from ORG1218/ORG1415/ORG1418).
- OriginGPS Noise Free Zone System (NFZ™) technology
- Fully integrating:

Antenna element, Dual-stage LNA, SAW filter, TCXO, RTC crystal, GNSS SoC, LDO regulator, RF shield

- GPS L1 1575.42 frequency, C/A code
- GLONASS L1 FDMA 1598-1606MHz frequency band, SP signal
- BEIDOU B1 1561.098MHz frequency band
- Galileo ready
- SBAS (WAAS, EGNOS, MSAS) and QZSS support
- Concurrent tracking of multiple constellations
- 52 channels
- Ultra-high Sensitivity down to -165dBm enabling Indoor Tracking
- TTFF of < 1s in 50% of trials under Hot Start conditions
- **I** Low Power Consumption of ≤ 15mW in ATP[™] mode
- High Accuracy of < 1.5m in 50% of trials
- High update rate of 10Hz, 1Hz by default
- Built in 16M-Bit Flash memory
- Autonomous A-GNSS by Client Generated Extended Ephemeris (CGEE™) for non-networked devices
- Predictive A-GNSS by Server Generated Extended Ephemeris (SGEE™) for connected devices





- Ephemeris Push™ for storing and loading broadcast ephemeris
- Host controlled power saving mode
- Self-managed low power modes ATP™, PTF™ and APM™, SiRFSmartGNSS™ I, SiRFSmartGNSS™ II, SiRFAware™.
- Multipath and cross-correlation mitigation
- Active Jammer Detector and Remover
- Smart Data Logging
- Fast Time Synchronization for rapid single satellite time solution
- ♣ ARM7® microprocessor system
- Selectable UART, SPI or I²C host interface
- NMEA protocol by default, switchable into One Socket Protocol (OSP®)
- Programmable baud rate and messages rate
- 1PPS Output
- Single voltage supply 3.3V
- Small LGA footprint of 17mm x 17mm
- Low weight of 8g
- Surface Mount Device (SMD)
- Optimized for automatic assembly and reflow equipment
- Operating from -40°C to +85°C
- FCC, CE, VCCI compliant
- RoHS II/REACH compliant





12.2 ARCHITECTURE

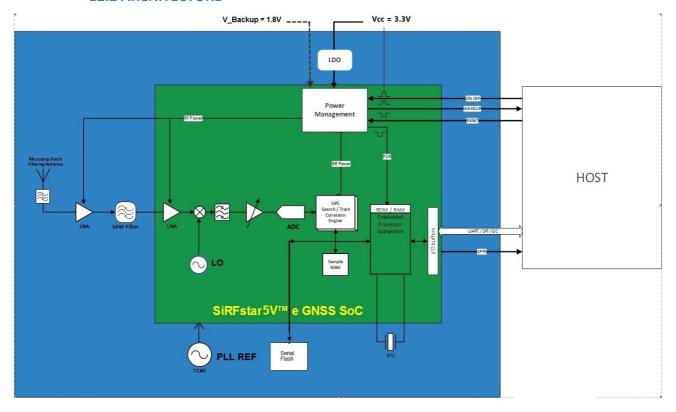


FIGURE 1 - ORG1518 ARCHITECTURE

Antenna

OriginGPS proprietary Microstrip Patch Antenna collects GNSS signals from the medium. Antenna is built from hi-K ceramic element mounted on top of RF shield, providing stable resonance.

GNSS SAW Filter

Band-Pass SAW filter eliminates out-of-band signals that may interfere to GNSS reception.

GNSS SAW filter is optimized for low Insertion Loss in GNSS band and low Return Loss outside it.

GNSS LNA

Dual-stage cascaded LNAs amplify GNSS signals to meet RF down converter input threshold. Noise Figure optimized design was implemented to provide maximum sensitivity.

TCXO

Highly stable 26MHz oscillator controls down conversion process in RF block of the GNSS SoC. Characteristics of this component are important factors for higher sensitivity, shorter TTFF and better navigation stability.

RTC crystal

Tuning fork 32.768KHz quartz crystal with very tight specifications is necessary for maintaining Hot Start and Warm Start capabilities of the module.

LDO regulator

RF LDO provides regulated voltage supply over wide input voltage range, with low quiescent current and high PSRR.





RF Shield

RF enclosure avoids external interference from compromising sensitive circuitry inside the module. RF shield also blocks module's internal high frequency emissions from being radiated.

SiRFstarV™ 5e B02 GNSS SoC

CSR 5e B02 is a 5-th generation SiRFstar[™] product.

It is a hybrid positioning processor that combines GPS+GLONASS / GPS + BEIDOU, GALILEO ready and SBAS data to provide a high performance navigation solution.

SiRFstarV[™] 5e B02 is a full SoC built on a low-power RF CMOS single-die, incorporating GNSS RF, GNSS baseband, integrated navigation solution software and ARM[®] processor.

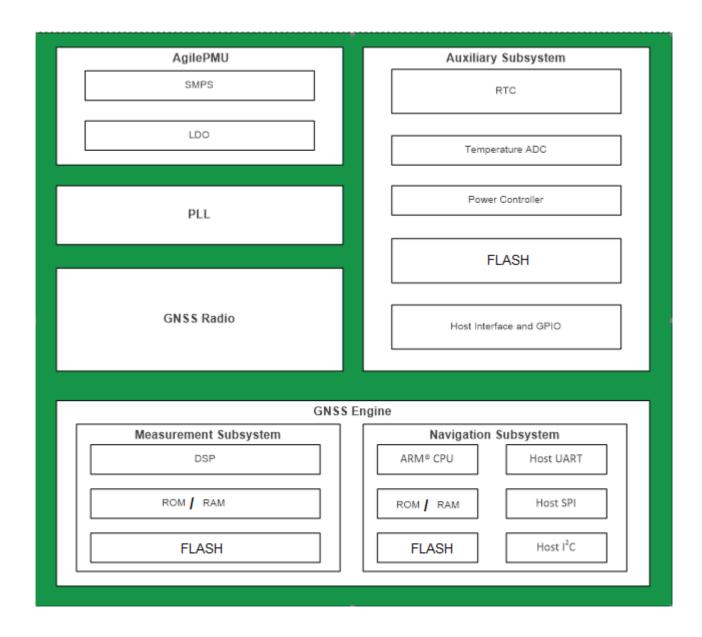


FIGURE 2 – SiRFstarV™ 5e B02 GNSS SoC BLOCK DIAGRAM





SiRFstarV[™] 5e B02 SoC includes the following units:

- GNSS radio subsystem containing single input dual receive paths for concurrent GPS and GLONASS, harmonic-reject double balanced mixer, fractional-N synthesizer, integrated self-calibrating filters, IF VGA with AGC, high-sample rate ADCs with adaptive dynamic range.
- Measurement subsystem including DSP core for GNSS signals acquisition and tracking, interference scanner and detector, wideband and narrowband interference removers, multipath and cross-correlation detectors, dedicated DSP code ROM and DSP cache RAM.
- Measurement subsystem interfaces GNSS radio subsystem.
- Built in 16M-Bit Flash memory.

 Serial flash is required to store firmware, LDK applications, user configurations and system-aiding data.
- Navigation subsystem comprising ARM7® microprocessor system for position, velocity and time solution, program ROM, data RAM, cache and patch RAM, host interface UART, SPI and I²C drivers.
- Navigation subsystem interfaces measurement subsystem.
- Auxiliary subsystem containing RTC block and health monitor, temperature sensor for reference clock compensation, battery-backed SRAM for satellite data storage, voltage supervisor with POR, PLL controller, GPIO controller, 48-bit RTC timer and alarms, CPU watchdog monitor.
- Auxiliary subsystem interfaces navigation subsystem, PLL and PMU subsystems.
- PMU subsystem containing voltage regulators for RF and baseband domains.





13. ELECTRICAL SPECIFICATIONS

13.1 ABSOLUTE MAXIMUM RATINGS

Stresses exceeding Absolute Maximum Ratings may damage the device.

PARAMETER	PARAMETER				MAX	UNIT
Power Supply Vo	Power Supply Voltage		V _{CC}		+5.50	V
Power Supply Co	Power Supply Current ¹		Icc		150	mA
RF Input Voltage	RF Input Voltage		V _{RF}	-25	+25	V
I/O Voltage			V _{IO}		+3.60	V
I/O Source/Sink	Current		lıo	-4	+4	mA
	1/0	HBM ⁴ method		-2000	+2000	V
	I/O pads	CDM ⁵ method	V _{IO(ESD)}	-400	+400	V
	Power pads	HBM ⁴ method		-2000	+2000	V
ESD Rating		CDM⁵ method	V _{CC(ESD)}	-500	+500	V
		HBM ⁴ method		-2000	+2000	V
		MM ⁶ method	V _{RF(ESD)}	-100	+100	V
RF Power ³	f _{IN} = 1560MHz	÷1630MHz	P _{RF}		+10	dBm
	f _{IN} <1560MHz, >1630MHz				+30	dBm
Power Dissipation	on		P _D		350	mW
Operating Temperature			Тамв	-40	+85	°C
Storage Temper	Storage Temperature			-55	+125	°C
Lead Temperatu	ıre ⁴		T _{LEAD}		+245	°C

TABLE 3 – ABSOLUTE MAXIMUM RATINGS

- 1. Inrush current of up to 100mA for about 20 μs duration.
- 2. Voltage applied on antenna element.
- 3. Power delivered to antenna element.
- 4. Human Body Model (HBM) contact discharge per EIA/JEDEC JESD22-A114D.
- 5. Charged Device Model (CDM) contact discharge per EIA/JEDEC JESD22-C101.
- 6. Machine Model (MM) contact discharge per EIA/JEDEC JESD22-A115C.
- 7. Lead temperature at 1mm from case for 10s duration.





13.2 RECOMMENDED OPERATING CONDITIONS

Exposure to stresses above Recommended Operating Conditions may affect device reliability.

PARAMETER	SYMBOL	MODE / PAD	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Power supply voltage	Vcc	Vcc		+2.60	+3.30	+5.50	V
			GPS		41	64	mA
		Acquisition ^a	GPS+GLONASS		50	68	mA
		Tracking ^b	GPS		40	44	mA
		Hacking	GPS+GLONASS		48.5	56.5	mA
Power Supply Current ¹	Icc	ATP™ Tracking ²			15	44	mA
		Standby ³			0.14	0.17	mA
		PTF™ ⁴			0.08		mA
		Hibernate			70	80	μΑ
Input Voltage Low State	V _{IL}			-0.30		+0.40	V
Input Voltage High State	V _{IH}			0.70·V _{CC}		+3.60	V
Output Voltage Low State	V _{OL}		I _{OL} = 2mA			+0.40	V
Output Voltage High State	Vон		I _{OH} = -2mA	0.75·Vcc			V
Input Capacitance	C _{IN}	GPIO -			5		pF
	D			0.11	1.00	2.75	МΩ
Internal Pull-up Resistors	R _{PU}		GPIO1, GPIO2			2.2	kΩ
Internal Pull-down Resistor	R _{PD}] [0.11	1.00	2.80	МΩ
Input Leakage Current	I _{IN(leak)}] [V _{IN} = 1.8V or 0V	-10		+10	μΑ
Output Leakage Current	I _{OUT(leak)}		$V_{OUT} = 1.8V \text{ or } 0V$	-10		+10	μΑ
Input Impedance	Z _{IN}		£ 4575 58411-		50		Ω
Input Return Loss	R _{LIN}	DE Innut	f _{IN} = 1575.5MHz	-7			dB
Input Power Range	Pin	- RF Input	GPS or GLONASS	-165		-110	dBm
Input Frequency Range	f _{IN}] [1560		1620	MHz
Operating Temperature ⁵	Тамв			-40	+25	+85	°C
Storage Temperature	T _{ST}			-55	+25	+125	°C
Relative Humidity ⁶	R _H		Тамв	5		95	%

TABLE 4 – RECOMMENDED OPERATING CONDITIONS

- a. Acquisition maximum values were measured with blocked signal, no GPS reception at all. Not a typical use case.
- b. Tracking maximum values were measured with a low signal level: ~20 dB. Not a typical use case.
- $1. \quad \text{Typical values under radiated signal conditions of -130dBm and ambient temperature of +25 °C.}$
- 2. ATP™ mode 200:1 (200ms on-time, 1s period), GPS-only tracking. The maximum value relates to the tracking part of ATP cycle.
- 3. Transitional states of $\mathsf{ATP^{\mathsf{TM}}}$ power saving mode.
- 4. PTF™ mode 30:30 (30s max. on-time 18s typical, 30m period), GPS-only tracking.
- 5. Longer TTFF is expected while operating below -30°C to -40°C.
- 6. Relative Humidity is within Operating Temperature range.





14. PERFORMANCE

14.1. ACQUISITION TIME

TTFF (Time To First Fix) – is the period of time from module's power-up till valid position estimation.

14.1.1 HOT START

Hot Start results either from a software reset after a period of continuous navigation or a return from a short idle period that was preceded by a period of continuous navigation.

During Hot Start all critical data (position, velocity, time, and satellite ephemeris) is valid to the specified accuracy and available in RAM.

14.1.2 SIGNAL REACQUISITION

Reacquisition follows temporary blocking of GNSS signals. Typical reacquisition scenario includes driving through tunnel.

14.1.3 AIDED START

Aided Start is a method of effectively reducing TTFF by providing valid satellite ephemeris data. Aiding can be implemented using Ephemeris Push™, CGEE™ or SGEE™.

14.1.4 WARM START

Warm Start typically results from user-supplied position and time initialization data or continuous RTC operation with an accurate last known position available in RAM. In this state position and time data are present and valid, but satellite ephemeris data validity has expired.

14.1.5 COLD START

Cold Start occurs when satellite ephemeris data, position and time data are unknown. Typical Cold Start scenario includes first power application.

OPERATION ¹	ON¹ MODE		UNIT	
Hot Start	< 1	S		
Aided Start	Aided Start			
Warm Start	GPS + GLONASS	< 26	S	
Walli Start	GPS	< 32	S	
Cold Start	GPS + GLONASS	< 27	S	
Cold Start	GPS	< 35	S	
Signal Reacquisition ²	< 1	S		

TABLE 5 - ACQUISITION TIME

- 1. EVK is 24-hrs. static under signal conditions of -130dBm and ambient temperature of +25°C.
- 2. Outage duration \leq 30s.





14.2. SENSITIVITY

14.2.1. TRACKING

Tracking is an ability of receiver to maintain valid satellite ephemeris data. During tracking receiver may stop output valid position solutions.

Tracking sensitivity defined as minimum GNSS signal power required for tracking.

14.2.2. REACQUISITION

Reacquisition follows temporary blocking of GNSS signals.

Reacquisition sensitivity defined as minimum GNSS signal power required for reacquisition.

14.2.3. NAVIGATION

During navigation receiver consequently outputs valid position solutions.

Navigation sensitivity defined as minimum GNSS signal power required for reliable navigation.

14.2.4. HOT START

Hot Start sensitivity defined as minimum GNSS signal power required for valid position solution under Hot Start conditions.

14.2.5. AIDED START

Aided Start sensitivity defined as minimum GNSS signal power required for valid position solution following aiding process.

14.2.6. COLD START

Cold Start sensitivity defined as minimum GNSS signal power required for valid position solution under Cold Start conditions, sometimes referred as ephemeris decode threshold.

OPERATION ¹	MODE	VALUE	UNIT
Tracking	GPS	-165	dBm
Tracking	GLONASS	-165	dBm
Naviantina	GPS	-164	dBm
Navigation	GLONASS	-164	dBm
Reacquisition ²		-162	dBm
Hot Start ³		-160	dBm
Aided Start ⁴		-156	dBm
Cold Start	GPS	-148	dBm

TABLE 6 - SENSITIVITY





14.3. RECEIVED SIGNAL STRENGTH

PARAMETER ⁵	VALUE	UNIT
C/N ₀	45	dB-Hz

TABLE 7 - RECEIVED SIGNAL STRENGTH

Notes:

- 1. EVK is static, ambient temperature is +25°C
- 2. Outage duration ≤ 30s.
- 3. Hibernate state duration ≤ 5 m.
- 4. Aiding using Broadcast Ephemeris (Ephemeris Push™) or Extended Ephemeris (CGEE™ or SGEE™).
- 5. Average C/N₀ reported for 4 SVs, EVK is 24-hrs. static, outdoor under open sky, ambient temperature is +25°C.

14.4 POWER CONSUMPTION

OPERATION ¹	MODE	VALUE	UNIT
A causinistic o	GPS		mW
Acquisition	GPS + GLONASS	90.5	mW
Tunaliina	GPS .		mW
Tracking	GPS + GLONASS	88	mW
	ATP™ Tracking ² 27		14/
Low Power Tracking	PTF™ ³	0.15	mW
	5m Hibernate: 10s tracking	2.4	mW
Hibe	126	μW	

TABLE 8 - ORG1518-R02 POWER CONSUMPTION

- 1. Voltage measured 3.3V
- 2. Typical values under radiated signal conditions of -130dBm and ambient temperature of +25°C.
- 3. ATP $^{\text{TM}}$ mode 100:1 (100ms on-time, 1s period), GPS-only tracking.
- 4. PTF™ mode 30:30 (30s max. on-time 18s typical, 30m period), GPS-only tracking.





14.4. ACCURACY

PARAMETER		FORMAT	MODE	VALUE	UNIT					
			GPS + GLONASS	< 1.5	m					
		CEP (50%)	GPS + SBAS	< 2.0	m					
	Horizontal		GPS	< 2.5	m					
	ПОПІДОПІСАІ		GPS + GLONASS	< 3.0	m					
		2dRMS (95%)	GPS + SBAS	< 4.0	m					
Position ¹			GPS	< 5.0	m					
Position		VEP (50%)	GPS + GLONASS	< 2.5	m					
			VEP (50%)	VEP (50%)	VEP (50%)	VEP (50%)	VEP (50%)	GPS + SBAS	< 3.5	m
	Vertical 20		GPS	< 4.0	m					
		2dRMS (95%)	GPS + GLONASS	< 5.0	m					
			GPS + SBAS	< 6.5	m					
			GPS	< 7.5	m					
Velocity ²	over ground	50% (50% of samples		m/s					
Heading	to north	50% of samples		< 0.01	0					
Time ¹		RMS jitter	1 PPS	≤ 30	ns					

TABLE 9 – ACCURACY

Notes:

- 1. Module is static under signal conditions of -130dBm, ambient temperature is +25°C.
- 2. EVK is 24-hrs. static, ambient temperature is +25°C.
- 3. Speed over ground \leq 30m/s.

14.5. DYNAMIC CONSTRAINS

PARAMETER	Metric	Imperial	
Velocity and Altitude ¹	515m/s and 18,288m 1,000knots and 60,0		
Velocity	600m/s	1,166knots	
Altitude	-500m to 24,000m	-1,640ft to 78,734ft	
Acceleration	4g		
Jerk	5m/s³		

TABLE 10 - DYNAMIC CONSTRAINS

Note:

1. Standard dynamic constrains according to regulatory limitations.





15. POWER MANAGEMENT

15.1. POWER STATES

15.1.1. FULL POWER ACQUISITION

ORG1518 module stays in Full Power Acquisition state until a reliable position solution is made. Switching to GPS-only mode turns off GLONASS RF block lowering power consumption.

15.1.2. FULL POWER TRACKING

Full Power Tracking state is entered after a reliable position solution is achieved. During this state the processing is less intense compared to Full Power Acquisition, therefore power consumption is lower. Full Power Tracking state with navigation update rate at 10Hz consumes more power compared to default 1Hz navigation.

15.1.3. CPU ONLY

CPU Only is the transitional state of ATP™ power saving mode when the RF and DSP sections are partially powered off. This state is entered when the satellites measurements have been acquired, but navigation solution still needs to be computed.

15.1.4. STANDBY

Standby is the transitional state of ATP™ power saving mode when RF and DSP sections are completely powered off and baseband clock is stopped.

15.1.5. HIBERNATE

ORG1518 module boots into Hibernate state after power supply applied.

During this state RF, DSP and baseband sections are completely powered off leaving only RTC and Battery-Backed RAM running.

ORG1518 will perform Hot Start if stayed in Hibernate state less than 4 hours from last valid position solution.

15.2. BASIC POWER SAVING MODE

Basic power saving mode is elaborating host in straightforward way for controlling transfers between Full Power and Hibernate states.

Current profile of this mode has no hidden cycles of satellite data refresh.

Host may condition transfers by tracking duration, accuracy, satellites in-view or other parameters.

15.3. SELF MANAGED POWER SAVING MODES

Multi Micro Hornet module has several self-managed power saving modes tailored for different use cases.

These modes provide several levels of power saving with degradation level of position accuracy. Initial operation in Full Power state is a prerequisite for accumulation of satellite data determining location, fine time and calibration of reference clocks.

15.3.1. ADAPTIVE TRICKLE POWER (ATP™)

ATP™ is best suited for applications that require navigation solutions at a fixed rate as well as low power consumption and an ability to track weak signals.

This power saving mode provides the most accurate position among self-managed modes.





In this mode the module is intelligently cycled between Full Power state, CPU Only state consuming 14mA and Standby state consuming \leq 100 μ A, therefore optimizing current profile for low power operation.

ATP™ period that equals navigation solution update can be 1 second to 10 seconds. On-time including Full Power Tracking and CPU Only states can be 200ms to 900ms.

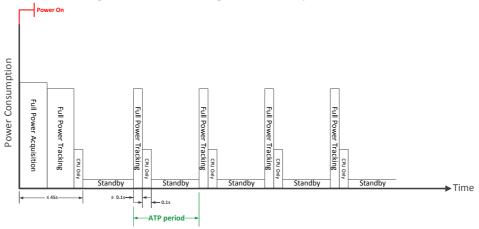


FIGURE 3 - ATP™ TIMING

15.3.2. PUSH TO FIX (PTF™)

PTF™ is best suited for applications that require infrequent navigation solutions.

In this mode ORG1518 module is mostly in Hibernate state, drawing \leq 54 μ A of current, waking up for satellite data refresh in fixed periods of time.

PTF™ period can be anywhere between 10 seconds and 2 hours.

Host can initiate an instant position report by toggle the ON_OFF pad to wake up the module. During fix trial module will stay in Full Power state until good position solution is estimated or pre-configured timeout for it has expired.

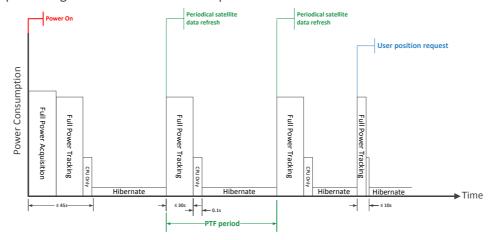


FIGURE 4 – PTF™ TIMING

15.3.3. ADVANCED POWER MANAGEMENT (APM™)

APM™ mode is designed for Aided-GPS wireless applications only.

APM[™] allows power savings while ensuring that the **Q**uality **o**f the **S**olution (QoS) in maintained when signals level drop.

In APM™ mode the module is intelligently cycled between Full Power and Hibernate states. In addition to setting the position report interval, a QoS specification is available that sets allowable error estimates and selects priorities between position report interval and more power saving.





User may select between Duty Cycle Priority for more power saving and Time Between Fixes (TBF) priority with defined or undefined maximum horizontal error.

TBF range is from 10s to 180s between fixes, Power Duty Cycle range is between 5% to 100%. Maximum position error is configurable between 1 to 160m.

The number of APM™ fixes is configurable up to 255 or set to continuous.

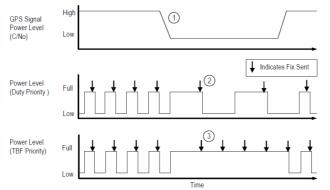


FIGURE 5 – APM™ TIMING

Notes:

- 1. GPS signal level drops (e.g. user walks indoor).
- 2. Lower signal results in longer ON time. To maintain Duty Cycle Priority, OFF time is increased.
- 3. Lower signal means missed fix. To maintain future TBFs module goes Full Power state until signal levels improve.

15.4 SMARTGNSS™ POWER MODES

In addition to the mentioned above power modes, Multi Hornet ORG1518-R02 introduces two new power saving modes, SiRFSmartGNSS I and SiRFSmartGNSS II, for continuous tracking and position reporting similar to full power. SiRFSmartGNSS modes are power saving alternatives for both GPS and GNSS operation while maintaining complete functionality of the device similar to full power.

ORG1518-R02 will always default to full power during the initial acquisition of the first fix, and will continue tracking in SiRFSmartGNSS if enabled. Therefore all first fix metrics for SiRFSmartGNSS are equivalent to full power performance. Power consumption will vary based on signal strength.

15.4.1 SiRFSmartGNSS™ I

SiRFSmartGNSS I autonomously manage the GPS or GNSS system usage based on satellite signal strength to save power. The adaptive mechanism will use fewer system resources during strong signal conditions and use more resources during weak signal conditions in order to maintain superior navigation performance. Full constellation tracking is maintained while in this mode. The criteria to enter and remain in SiRFSmartGNSS I is a valid position fix with 6 or more satellites above 24 dB-Hz, otherwise the receiver switches to full power.

15.4.2 SiRFSmartGNSS™ II

SiRFSmartGNSS II includes the benefits of SiRFSmartGNSS I and achieves further power reduction by minimizing the usage of the secondary GNSS constellation. The adaptive mechanism will adjust constellation usage based on GPS signal conditions to maintain good performance while minimizing power. As an example, in the case of GPS + GLONASS mode of operation, the GLONASS satellite usage will be minimized during strong GPS satellite conditions. SiRFSmartGNSS II is only applicable for multi-constellation operation.





The criteria to enter and remain in SiRFSmartGNSS II is a valid position fix with 4 or more satellites above 24 dB-Hz, otherwise the receiver switches to full power.

15.4.3 SiRFAware™

SiRFAware™ is a very low-power maintenance mode. The objective of SiRFAware is to remain below a stated average current level while maintaining a low level of uncertainty in time, frequency, position and ephemeris state.

SiRFAware™ operates by capturing a buffer of GPS samples at infrequent intervals and analyzing the data to update its time, frequency and position estimates. For satellites needing updated ephemeris data, a data collection is scheduled when strong signals are detected. During the data collection phase, time and frequency calibration operations are also carried out.

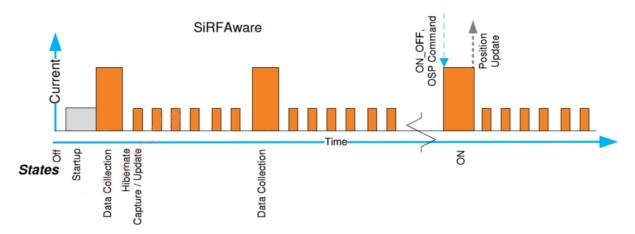


Figure 6 - SiRFAware™ Current Profile

Typical Capture/Update frequency varies: about once every ten minutes for 9 seconds. Data collection in SiRFAware is managed to limit power consumption. When data collection is required, it is timed to collect just the required data. Data collection is twice an hour at ~18 seconds each.

SiRFAware allows the user to make the request at any time. The criterion to enter and remain in SiRFAware cycling is a valid Kalman-Filter position fix. If the receiver cannot transition to its cycling mode it will sleep for 10 minutes and try again. If signals are strong enough to get the initial ephemeris to make a valid navigation solution, the receiver will stay awake to collect the data and start a successful SiRFAware cycle.

16. EXTENDED FEATURES

16.1. ALMANAC BASED POSITIONING (ABP™)

With ABP™ mode enabled, the user can get shorter Cold Start TTFF as tradeoff with position accuracy. When no sufficient ephemeris data is available to calculate an accurate solution, a coarse solution will be provided where the position is calculated based on one or more of the GPS satellites, having their states derived from the almanac data.

Data source for ABP™ may be either stored factory almanac, broadcasted or pushed almanac.





16.2. ACTIVE JAMMER DETECTOR AND REMOVER

Jamming Detector is embedded DSP software block that detects interference signals in GPS L1 and GLONASS L1 band.

Jamming Remover is additional DPS software block that sort-out Jamming Detector output mitigating up to 8 interference signals of Continuous Wave (CW) type up to 80dB-Hz each.

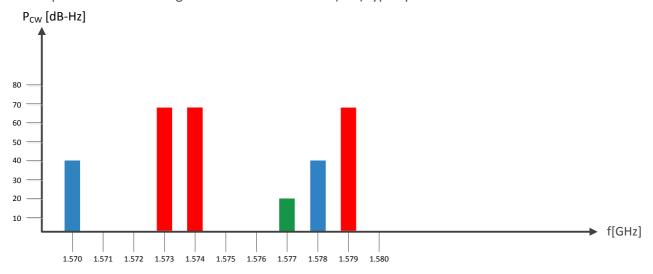


FIGURE 7 – ACTIVE JAMMER DETECTOR FREQUENCY PLOT

16.3. CLIENT GENERATED EXTENDED EPHEMERIS (CGEE™)

CGEE™ feature allows shorter TTFFs by providing predicted (synthetic) ephemeris files created within a non-networked host system from previously received satellite ephemeris data.

The prediction process requires good receipt of broadcast ephemeris data for all satellites.

EE files created this way are good for up to 3 days and then expire.

CGEE™ feature requires avoidance of power supply removal.

CGEE™ data files are stored and managed by host.

16.4. SERVER GENERATED EXTENDED EPHEMERIS (SGEE™)

SGEE™ enables shorter TTFFs by fetching Extended Ephemeris (EE) file downloaded from web server.

Host is initiating periodic network sessions of EE file downloads, storage and provision to module.

There is one-time charge for set-up, access to OriginGPS EE distribution server and end-end testing for re-distribution purposes, or there is a per-unit charge for each module within direct SGEE™ deployment.

GPS EE files are provided with look-ahead of 3 days.





17. INTERFACE

17.1. PAD ASSIGNMENT

Pad Number	Pad Name	Function			Direction	
1	RX	UART Receive	SPI Data In	I ² C Data	Bi-directional	
2	TX	UART Transmit	SPI Data Out	I ² C Clock	Bi-directional	
3	V_backup		V battery input		Power	
4	CTS	Interface Select 1	UART Clear To Send	SPI Clock	Bi-directional	
5	RTS	Interface Select 2	UART Ready To Send	SPI Chip	Bi-directional	
6	BOOT MODE		Boot Mode		Bi-directional	
7	EN		Enable module		Power	
8	VCC		System Power		Power	
9	1V8	1	8V Regulated output		Power	
10	GND		System Ground		Power	
11	GND	System Ground			Power	
12	GND	System Ground			Power	
13	GPIO 2	GPIO		Bi-directional		
14	GPIO 8	GPIO		Bi-directional		
15	WAKEUP		Power Status		Output	
16	nRESET		Asynchronous Reset		Input	
17	ON_OFF	Power State Control		Input		
18	GPIO B	I2C MEMS Data		I2C MEMS Data		Bi-directional
19	GPIO C	I2C MEMS Clock		Bi-directional		
20	EIT	External Interrupt		External Interrupt		Bi-directional
21	1PPS	UTC Time Mark		UTC Time Mark		Output
22	GPIO A	GPIO			Bi-directional	

TABLE 11 - PIN-OUT

^{**}Please notice: all GPIO are disabled by default.





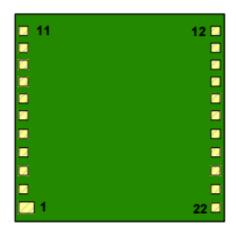


FIGURE 8 - FOOTPRINT

17.2. POWER SUPPLY

It is recommended to keep the power supply on all the time, or connect a V_backup input, in order to maintain RTC block active and keep satellite data in RAM for fastest possible TTFF.

When V_{CC} is removed and there is no V_{CC} backup input - settings are reset to factory default and the receiver performs Cold Start on next power up.

17.2.1. VCC = 3.3V

V_{CC} is 3.3V DC nominal and can be within range of 2.2-5.5 V DC.

V_{CC} must be provided from regulated power supply.

Inrush current is up to 150mA for about 20µs duration.

Typical I_{cc} during acquisition is 55mA. Lower acquisition current is possible disabling GLONASS radio path by software command.

During tracking the processing is less intense compared to acquisition, therefore power consumption is lower.

Maximum I $_{\text{CC}}$ current in Hibernate state is 54 μ A, while all I/O lines externally held in Hi-Z state.

Output capacitors are critical when powering ORG1518 from switch-mode power supply.

Filtering is important to manage high alternating current flows on the power input connection.

An additional LC filter on ORG1518 power input may be needed to reduce system noise.

The high rate of ORG1518 input current change requires low ESR bypass capacitors.

Additional higher ESR output capacitors can provide input stability damping.

The ESR and size of the output capacitors directly define the output ripple voltage with a given inductor size. Large low ESR output capacitors are beneficial for low noise.

Voltage ripple below 50mV_{PP} allowed for frequencies between 100KHz to 1MHz.

Voltage ripple below $15 mV_{PP}$ allowed for frequencies above 1 MHz.

Higher voltage ripple may compromise ORG1518 performance.





17.2.2. GROUND

Ground pad must be connected to host PCB Ground with shortest possible trace or by multiple vias.

17.3. CONTROL INTERFACE

17.3.1. ON_OFF input

ON_OFF input in ORG1518-R02 turns the module to hibernate or full power state according to input:

- High-level input initiates system transitions from full power to Hibernate.
- Low-level input initiates transition from hibernate to full power.
- While in PTF™ mode, an ON_OFF pulse will initiate one PTF™ request. The module will wait for a fix, update required satellites data and go back to Hibernate mode.

17.3.2. WAKEUP

WAKEUP output from module is used to indicate power state.

A low logic level indicates that the module is in one of its low-power states - Hibernate or Standby. A high logic level indicates that the module is in Full Power state.

Connecting WAKEUP to ON OFF enables autonomous start to Full Power state.

In addition WAKEUP output can be used to control auxiliary devices.

Wakeup output is LVCMOS 1.8V compatible.

Do not connect if not in use.

17.3.3. **RESET**

Power-on-Reset (POR) sequence is generated internally.

In addition, external reset is available through RESET pad.

Resetting module clears the state machine of self-managed power saving modes to default.

RESET signal should be applied for at least 1µs.

RESET input is active low and has internal pull-up resistor of $1M\Omega$.

Do not drive this input high.

Do not connect if not in use.

17.3.4. 1PPS

Pulse-Per-Second (PPS) output provides a pulse signal for timing purposes.

PPS output starts when 3D position solution has been obtained using 5 or more GNSS satellites.

PPS output stops when 3D position solution is lost.

Pulse length (high state) is 200ms with rising edge is less than 30ns synchronized to UTC epoch.

The correspondent UTC time message is generated and put into output FIFO 300ms after the PPS signal. The exact time between PPS and UTC time message delivery depends on message rate, message queue and communication baud rate.

1PPS output is LVCMOS 1.8V compatible.

Do not connect if not in use.





17.3.5 BOOT MODE

SiRFstarV always starts up in Boot mode when it comes out of a reset or at initial power up. It then performs three tests. If all three tests pass, SiRFstarV switches to Operational mode. If any of the tests fail, SiRFstarV remains in Boot mode and waits for input, usually from SiRFLive, SiRFFlashcl or similar tools.

The Order of the tests performed is:

- 1. Test of serial flash. If flash is corrupted, go to Boot mode.
- 2. Read BOOTMODE pin. If pulled high, go to Boot mode.
- 3. Test the data in serial flash against a stored CRC32. If the test fails, go to Boot mode

In boot mode a special ROM boot loader controls the receiver.

In this mode the receiver can only execute a special set of commands that the SiRFLive utility uses to program the flash. Interrupts are disabled and no receiver resources are available other than the serial port.

17.3.6 V Backup

In order to maintain configuration settings after a power cycle, the backup power is necessary.

V_backup is also necessary to save information such as SGEE and almanac on flash, without the need to upload this data after a power cycle. Storing this information will provide faster TTFF.

 $V_backup = 1.8V$

17.3.7 Second I2C port

The second I2C port is used to connect MEMS sensors in a master-slave mode. This is additional I2C port. The main I2C port is working in multi-master mode.

17.4. DATA INTERFACE

ORG1518 module has 3 types of interface ports to connect to host - UART, SPI or I^2C – all multiplexed on a shared set of pads. At system reset host port interface lines are disabled, so no conflict occurs. Logic values on \overline{CTS} and \overline{RTS} are read by the module during startup and define host port type. External resistor of $10k\Omega$ is recommended. Pull-up resistor is referenced to 3.3V.

PORT TYPE	CTS	RTS
UART(default)	External pull-up	Internal pull-up
SPI	Internal pull-down	Internal pull-up
I ² C	Internal pull-down	External pull-down

TABLE 12 – HOST INTERFACE SELECT

17.4.1 UART

Multi Hornet ORG1518 has a standard UART port:

- TX used for GPS data reports. Output logic high voltage level 1.8V compatible.
- RX used for receiver control. Input logic high voltage level is 2.20V, tolerable up to 3.6V.
- UART flow control using CTS and RTS lines is disabled by default.

 Can be turned on by sending OSP®Message ID 178, Sub ID 2 input command.





17.4.2 SPI

SPI host interface features are:

- Slave SPI Mode 1, supports clock up to 6.8MHz.
- RX and TX have independent 2-byte idle patterns of '0xA7 0xB4'.
- TX and RX each have independent 1024 byte FIFO buffers.
- TX FIFO is disabled when empty and transmits its idle pattern until re-enabled.
- RX FIFO detects a software specified number of idle pattern repeats and then disables FIFO input until the idle pattern is broken.
- FIFO buffers can generate an interrupt at any fill level.
- SPI detects synchronization errors and can be reset by software.
- Output is LVCMOS 1.8V compatible. Inputs are tolerable up to 3.6V.

17.4.3 I²C

I²C host interface features are:

- 1²C Multi-Master Mode module initiates clock and data, operating speed 400kbps.
- I²C address '0x60' for RX and '0x62' for TX.
- Individual transmit and receive FIFO length of 64 bytes.
- Clock rate can be switched 100KHz (default 400KHz), address can be changed (default 0x62 for TX FIFO and 0x60 for RX FIFO) by sending OSP Message ID 178, Sub ID 2 input command.
- SCL and SDA are pseudo open-drain lines, therefore require external pull-up resistors of $2.2k\Omega$ to 1.8V, or $3.3k\Omega$ to 3.3V.





18. TYPICAL APPLICATION CIRCUIT

18.1 UART HOST INTERFACE

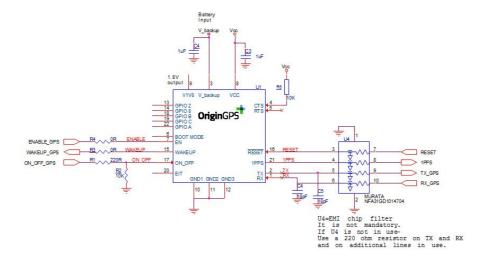


FIGURE 9 - REFERENCE SCHEMATIC DIAGRAM OF UART HOST INTERFACE

18.2 SPI HOST INTERFACE

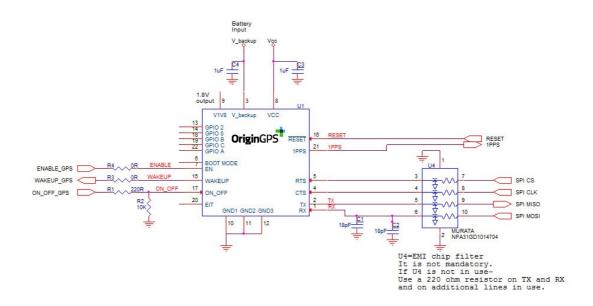


FIGURE 10 – REFERENCE SCHEMATIC DIAGRAM OF SPI HOST INTERFACE





18.3 I2C HOST INTERFACE

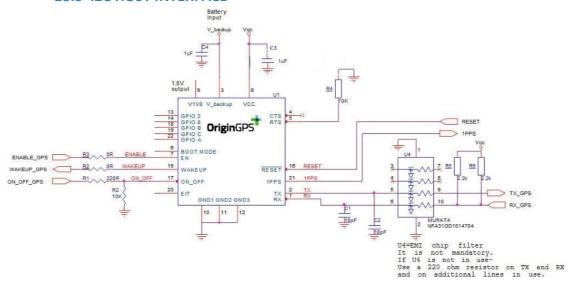


FIGURE 11 - REFERENCE SCHEMATIC DIAGRAM OF I2C HOST INTERFACE

19. RECOMMENDED PCB LAYOUT

19.1. FOOTPRINT

4 supporting pads on the surrounding of the footprint must be solder masked. They are floating inside the module.

8 straightening pads, each one containing 4 squares - are recommended to be also solder masked. The purposed of all the 12 straightening and supporting pads is to add mechanical strength to the module. See figure 12 – bottom view.

Ground paddle at the middle must be solder masked.

Silk print of module's outline is highly recommended for SMT visual inspection.

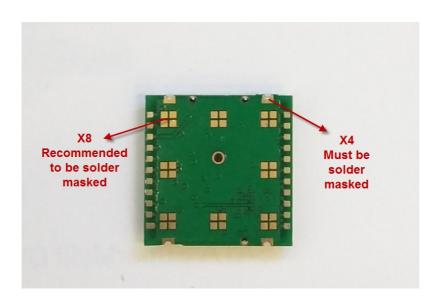


FIGURE 12 – SUPPORTING PADS





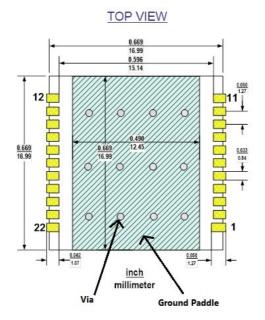


FIGURE 13 - MODULE'S FOOTPRINT

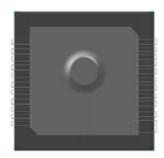


FIGURE 14 – MODULE HOSTED ON FOOTPRINT

19.2. HOST PCB

Special attention should be paid during GPS module placement and position on host PCB.

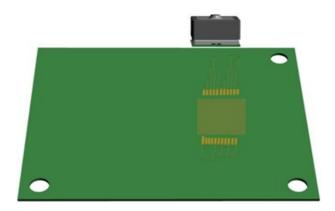


FIGURE 15 – MODULE PLACEMENT





19.3. PCB STACK-UP

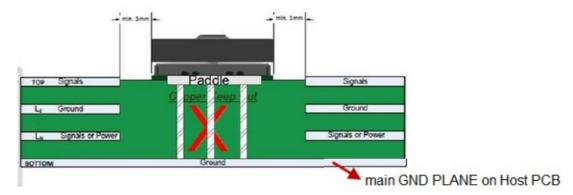


FIGURE 16 - TYPICAL PCB STACK-UP

19.4. PCB LAYOUT RESTRICTIONS

Switching and high-speed components, traces and vias must be kept away from ORG1518 module. Signal traces to/from module should have minimum length.

Recommended minimal distance from adjacent active components is 3mm.

Ground pads must be connected to host PCB Ground with shortest possible traces or vias.

In case of tight integration constrain or co-location with adjacent high speed components like CPU or memory, high frequency components like transmitters, clock resonators or oscillators, LCD panels or CMOS image sensors, contact OriginGPS for application specific recommendations.

19.5. MODULE POSITIONING RECOMENDATION ON RECTANGULAR BOARD

The host board serves as module's ground plane. The location and orientation of the module on the host board has a significant influence to module's performance.

Due to ground plane considerations, to achieve best GPS performance on a rectangular board it is recommended to place the ORG1518 module in the following relative location and orientation:

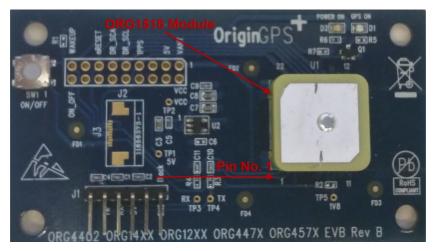


FIGURE 17 - MODULE'S ORIENTATION ON PCB





20. DESIGN CONSIDERATIONS

ORG1518 incorporates on-board antenna element that is perfectly matched to receiver front-end, frequency trimmed to GPS band and Right-Hand Circularly Polarized (RHCP).

OriginGPS proprietary module structure is providing stable resonance of antenna in GPS band with very low dependence on host PCB size, it's conducting planes geometry and stack-up.

To prevent PCB factor on antenna resonance avoid copper pouring on module side.

To prevent module orientation from causing polarization losses in on-board antenna avoid long and narrow copper planes beneath.

ORG1518 operates with received signal levels down to -165dBm and can be affected by high absolute levels of RF signals out of GNSS band, moderate levels of RF interference near GNSS band and by low-levels of RF noise in GNSS band.

RF interference from nearby electronic circuits or radio transmitters can contain enough energy to desensitize ORG1518. These systems may also produce levels of energy outside of GNSS band, high enough to leak through RF filters and degrade the operation of the radios in ORG1518.

This issue becomes more critical in small products, where there are industrial design constraints.

In that environment, transmitters for Wi-Fi, Bluetooth, RFID, cellular and other radios may have antennas physically close to ORG1518.

To prevent degraded performance of ORG1518, OriginGPS recommends performing EMI/jamming susceptibility tests for radiated and conducted noise on prototypes and assessing risks of other factors.

Contact OriginGPS for application specific recommendations and design review services.

21. OPERATION

21.1. STARTING THE MODULE

When power is first applied, module goes into a Reset state . If RESET pad is high, the module will remain in Reset state. Internal RTC oscillator takes up to 1 second to be ready after initial application of power. When the RTC oscillator is ready and RESET pad is low – the module transits to ON state.

The transition from RESET to ON is indicated by high output on the WAKEUP pad. After initialization is complete, an OK-to-Send=TRUE message is output to the host serial port indicating that the system firmware is operating and ready to receive commands from the host.

21.2. VERIFYING THE MODULE HAS STARTED

WAKEUP output will go high indicating module has started.

System activity indication depends upon selected serial interface.

The first message to come out of module is "OK_TO_SEND" - '\$PSRF150,1*3E'.

21.2.1 UART

When active, the module will output NMEA messages at the 4800bps.

21.2.2 I²C

In Multi-Master mode with no bus contention - the module will spontaneously send messages. In Multi-Master mode with bus contention - the module will send messages after the I^2C bus contention resolution process allows it to send.





21.2.3 SPI

Since module is SPI slave device, there is no possible indication of system "ready" through SPI interface. Host must initiate SPI connection approximately 1s after WAKEUP output goes high.

21.3. CHANGING PROTOCOL AND BAUD RATE¹

Protocol and baud rate can be changed by NMEA \$PSRF100 serial message.

21.4. CHANGING SATELLITE CONSTELLATION¹

Satellite constellations used in position solution can be changed by OSP® Message ID 222 Sub ID 16.

21.5. TRANSITION FROM FULL POWER TO HIBERNATE

Transferring module from Full Power state to Hibernate state can be initiated in two ways:

- By a high level input on ON_OFF input.
 In this case, transition back to Full Power mode is done by low level input on On_Off pad.
- By NMEA (\$PSRF117) or OSP (MID205) serial message.
 In this case, transition back to Full Power mode is done by a pulse on On_Off pad.

<u>Important:</u> While in Hibernate mode – the module cannot receive any software commands and can be controlled only by hardware.

Orderly shutdown process may take anywhere from 10ms to 900ms to complete, depending upon operation in progress and messages pending, and hence is dependent upon serial interface speed and controls. Module will stay in Full Power state until TX FIFO buffer is emptied.

The last message during shutdown sequence is '\$PSRF150,0*3F'.

Note:

1. Changes to default firmware settings are volatile and will be discarded at power re-cycle.





22. FIRMWARE

22.1. DEFAULT SETTINGS

Power On State		On	
Default Interface ¹		UART	
UART Da	ata Format	NMEA	
UART	Settings	4,800bps.	
SPI Dat	a Format	NMEA	
I ² C So	ettings	Multi-Master 400kbps	
I ² C Dat	a Format	NMEA	
Satellite C	onstellation	GPS + GLONASS / GPS + BEIDOU	
		\$GPGGA @1 sec.	
		\$GNGNS @ 1 sec.	
NIN 45 A		\$GNGSA @ 1 sec.	
NMEA Messages		\$GPGSV @ 5 sec.	
		\$GLGSV @ 5 sec.	
		\$GNRMC @ 1 sec.	
	SBAS	OFF	
	АВР™	OFF	
	Static Navigation	ON	
	Track Smoothing	OFF	
	Jammer Detector	ON	
Firmware Defaults	Jammer Remover	OFF	
Firmware Defaults	Fast Time Sync	OFF	
	Pseudo DR Mode	ON	
	Power Saving Mode	OFF	
	3SV Solution Mode	ON	
	Data Logger	OFF	
	10Hz Update Rate	OFF	

TABLE 13 - DEFAULT FIRMWARE SETTINGS

22.2. FIRMWARE UPDATES

Firmware of ORG1518-R02 is loaded into serial flash.

Updated firmware may be provided by OriginGPS as a method of performance improvement. Typical firmware file size is 1100KB.

Host controller is initiating load and application of firmware update.

SiRFstarV firmware, CCK settings and user applications are always protected in serial flash against corruption of unexpected power removal. SiRFstarV protects all data elements in battery-backed memory and serial flash memory with a CRC-32. All data elements are well protected and recoverable.





Note:

1. Without external resistor straps on $\overline{\text{CTS}}$ or $\overline{\text{RTS}}$.

23. HANDLING INFORMATION

23.1. MOISTURE SENSITIVITY

ORG1518 modules are MSL 3 designated devices according to IPC/JEDEC J-STD-033B standard.

Module in sample or bulk package should be baked prior to assembly at 125°C for 48 hours.

23.2. ASSEMBLY

The module supports automatic pick-and-place assembly and reflow soldering processes. Suggested solder paste stencil is 5 mil to ensure sufficient solder volume.

23.3. SOLDERING

Reflow soldering of the module always on component side (Top side) of the host PCB according to standard IPC/JEDEC J-STD-020D for LGA SMD.

Avoid exposure of ORG1518 to face-down reflow soldering process.

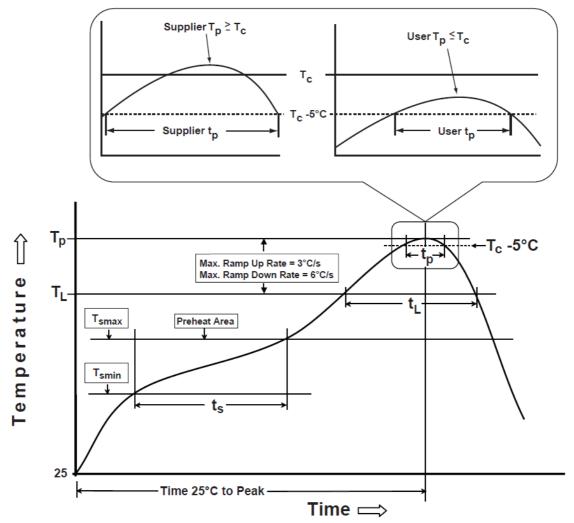


FIGURE 18 - RECOMMENDED SOLDERING PROFILE





Referred temperature is measured on top surface of the package during the entire soldering process. Suggested peak reflow temperature is 245°C for 30 sec. for Pb-Free solder paste.

Actual board assembly reflow profile must be developed individually per furnace characteristics.

Reflow furnace settings depend on the number of heating/cooling zones, type of solder paste/flux used, board design, component density and packages used.

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
Tc	Classification Temperature		245		°C
T _P	Package Temperature			245	°C
TL	Liquidous Temperature		217		°C
Ts	Soak/Preheat Temperature	150		200	°C
ts	Soak/Preheat Time	60		120	S
t _L	Liquidous Time	60		150	S
t₽	Peak Time		30		S

TABLE 14 – SOLDERING PROFILE PARAMETERS

23.4. CLEANING

If flux cleaning is required, module is capable to withstand standard cleaning process in vapor degreaser with the Solvon® n-Propyl Bromide (NPB) solvent and/or washing in DI water.

Avoid cleaning process in ultrasonic degreaser, since specific vibrations may cause performance degradation or destruction of internal circuitry.

23.5. REWORK

If localized heating is required to rework or repair the module, precautionary methods are required to avoid exposure to solder reflow temperatures that can result in permanent damage to the device.

23.6. ESD SENSITIVITY

This product is ESD sensitive device and must be handled with care.



23.7. SAFETY INFORMATION

Improper handling and use can cause permanent damage to the product.

23.8. DISPOSAL INFORMATION

This product must not be treated as household waste.

For more detailed information about recycling electronic components contact your local waste management authority.







24. MECHANICAL SPECIFICATIONS

- **Solution** ORG1518 module has advanced miniature packaging in LGA SMD footprint sized 17mm x 17mm.
- The module is built on miniature PCB enclosed with metallic shield box.
- The module has 22 SMT pads with copper base/ENIG plating on the bottom side.
- The package of the module has been optimized for automated pick and place assembly and reflow soldering processes.

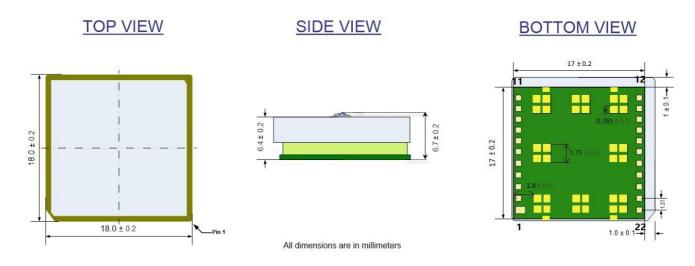


FIGURE 19 - ORG1518 MECHANICAL DRAWING

Dimensions	Length	Width	Height	Weight	
mm	18.0 ± 0.2	18.0 ± 0.2	6.7 ± 0.2	gr	8
inch	0.709 ± 0.008	0.709 ± 0.008	0.264 ± 0.008	OZ	0.28

TABLE 15 - MECHANICAL SUMMARY

25. COMPLIANCE

The following standards are applied on the production of ORG1518 modules: ±

- IPC-6011/6012 Class2 for PCB manufacturing
- IPC-A-600 Class2 for PCB inspection
- IPC-A-610D Class2 for SMT acceptability

ORG1518 modules are manufactured in ISO 9001:2008 accredited facilities.

ORG1518 modules are manufactured in ISO 14001:2004 accredited facilities.

ORG1518 modules are manufactured in OHSAS 18001:2007 accredited facilities.

ORG1518 modules are designed, manufactured and handled in compliance with the Directive 2011/65/EU of the European Parliament and of the Council of June 2011 on the Restriction of the use of certain Hazardous Substances in electrical and electronic equipment, referred as RoHS II.







ORG1518 modules are manufactured and handled in compliance with the applicable substance bans as of Annex XVII of Regulation 1907/2006/EC on Registration, Evaluation, Authorization and Restriction of Chemicals including all amendments and candidate list issued by ECHA, referred as REACH.



ORG1518 modules comply with the following EMC standards:

- EU CE EN55022:06+A1(07), Class B
- US FCC 47CFR Part 15:09, Subpart B, Class B
- JAPAN VCCI V-3/2006.04



26. PACKAGING AND DELIVERY

26.1. APPEARANCE

ORG1518 modules are delivered in reeled tapes for automatic pick and place assembly process.

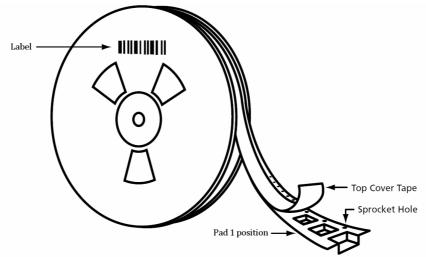


FIGURE 20 - MODULE POSITION

ORG1518 modules are packed in 2 different reel types.

SUFFIX	TR1	TR2
Quantity	150	500

TABLE 16 - REEL QUANTITY

Reels are dry packed with humidity indicator card and desiccant bag according to IPC/JEDEC J-STD-033B standard for MSL 3 devices.

Reels are vacuum sealed inside anti-static moisture barrier bags.

Sealed reels are labeled with MSD sticker providing information about:

- MSL
- Shelf life
- Reflow soldering peak temperature
- Seal date

Sealed reels are packed inside cartons.

Reels, reel packs and cartons are labeled with sticker providing information about:

Description





- Part number
- Lot number
- Customer PO number
- Quantity
- Date code

26.2. CARRIER TAPE

Carrier tape material - polystyrene with carbon (PS+C).

Cover tape material – polyester based film with heat activated adhesive coating layer.

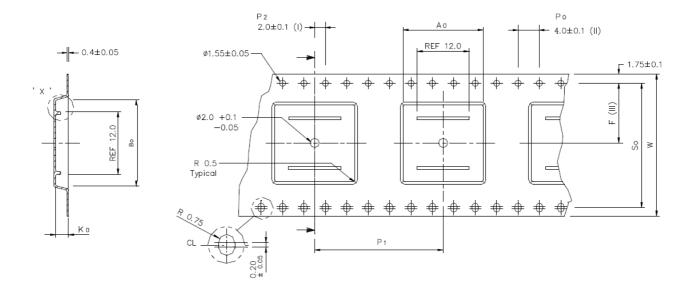


FIGURE 21 - CARRIER TAPE

	ORG1218	ORG1208
A ₀	20.50 ± 0.1	18.00 ± 0.1
B ₀	20.50 ± 0.1	18.00 ± 0.1
K ₀	07.30 ± 0.1	03.60 ± 0.1
F	14.20 ± 0.1	14.20 ± 0.1
P ₁	24.00 ± 0.1	24.00 ± 0.1
S ₀	28.40 ± 0.1	28.40 ± 0.1
W	32.00 ± 0.3	32.00 ± 0.3

TABLE 17 – CARRIER TAPE DIMENSIONS





26.3. REEL

Reel material - antistatic plastic.

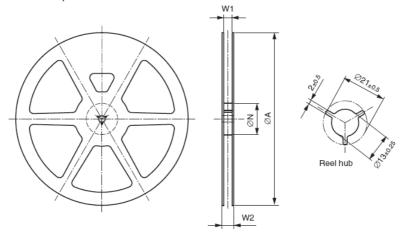


FIGURE 22 - REEL

SUFFIX	TR1			
	mm	inch		
ØΑ	330.0 ± 2.0	13.00 ± 0.08		
ØN	102.0 ± 2.0	4.02 ± 0.08		
W1	16.7 ± 0.5	0.66 ± 0.02		
W2	22.2 ± 0.5	0.87 ± 0.02		

TABLE 18 - REEL DIMENSIONS

27. ORDERING INFORMATION

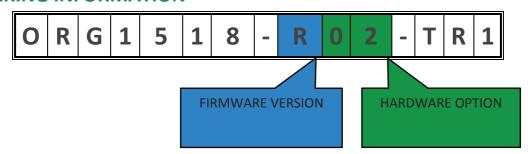


TABLE 19 - ORDERING OPTIONS

PART NUMBER	FW VERSION	HW OPTION	V _{cc} RANGE	PACKAGING	SPQ
ORG1518-R02-TR1	3	02	3.3V	REELED TAPE	150
ORG1518-R02-TR2	3	02	3.3V	REELED TAPE	500
ORG1518-R02-UAR	3	02	5V USB	EVALUATION KIT	1

TABLE 20 – ORDERABLE DEVICES

The default constellation is GPS and GLONASS.

GPS and BEIDOU constellation is also available. For ordering this option contact marketing@origingps.com